

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	145	W	8/20μs, Per Figure 3
Peak Pulse Current	I _{PP}	10	A	8/20μs, Per Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±30	kV	Standard IEC 61000-4-2

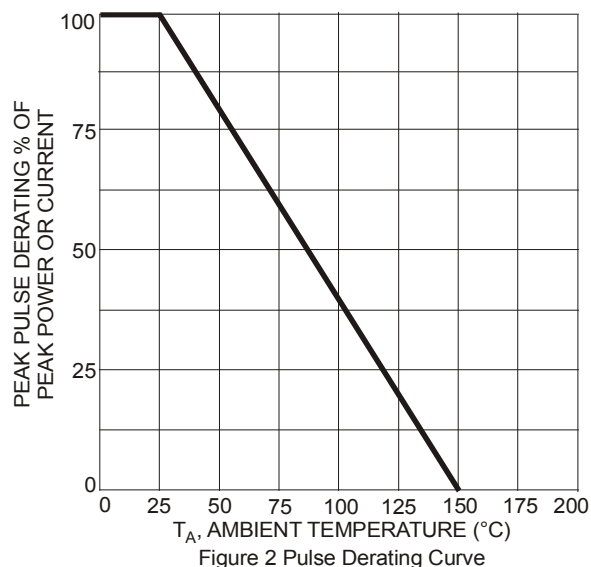
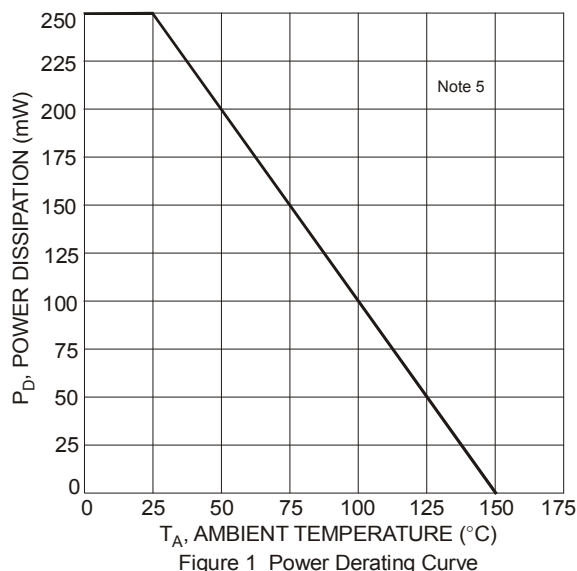
Thermal Characteristics

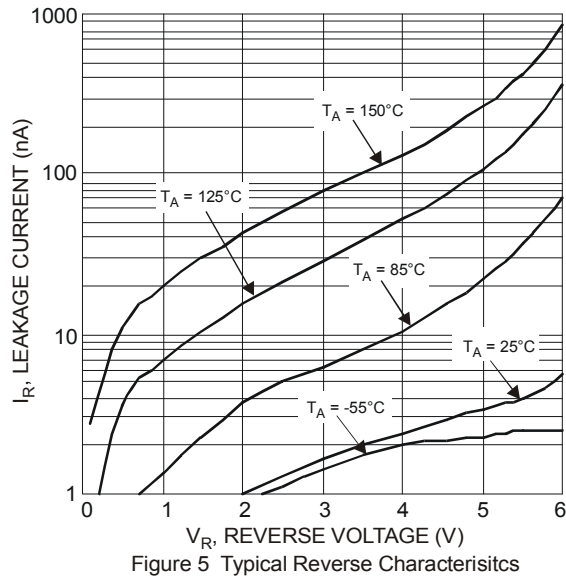
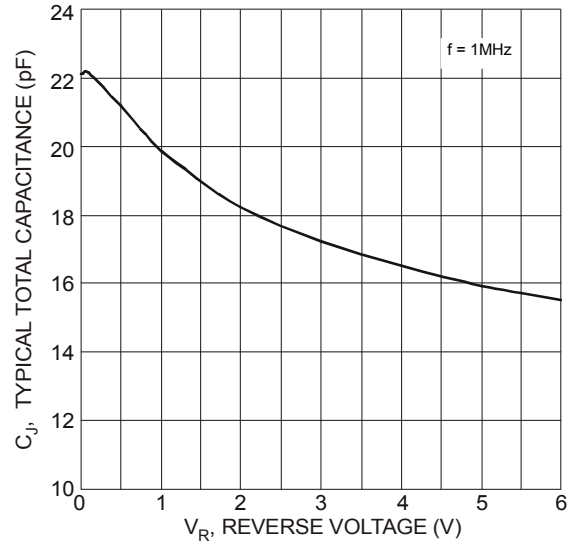
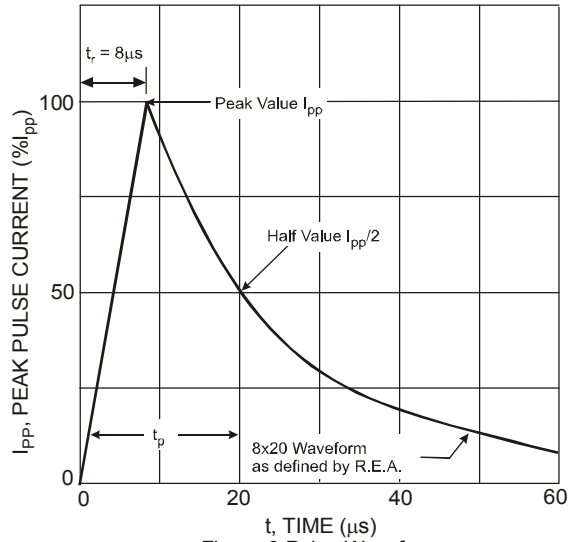
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	—	—	5	V	—
Channel Leakage Current (Note 6)	I _{RM}	—	1	100	nA	V _{RWM} = 5V
Clamping Voltage, Positive Transients	V _{CL}	—	—	10	V	I _{PP} = 1A, t _p = 8/20μs
		—	—	14.5	V	I _{PP} = 10A, t _p = 8/20μs
Breakdown Voltage	V _{BR}	6	—	9.5	V	I _R = 1mA
Differential Resistance	R _{DIF}	—	0.5	—	Ω	I _{PP} = 10A, t _p = 8/20μs
Channel Input Capacitance	C _T	—	22	28	pF	V _R = 0V, f = 1MHz
		—	16	22		V _R = 5V, f = 1MHz

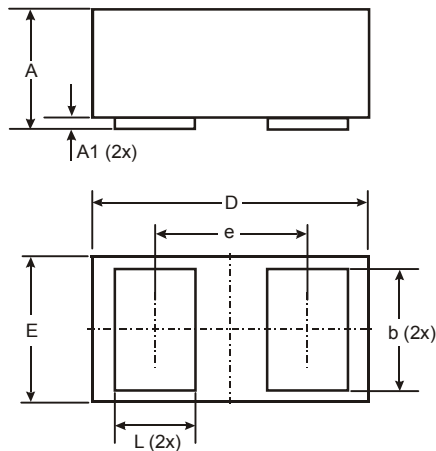
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
 6. Short duration pulse test used to minimize self-heating effect.





Package Outline Dimensions

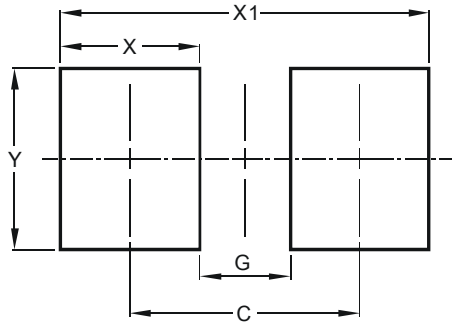
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



X3-DFN0603-2			
Dim	Min	Max	Typ
A	0.27	0.35	0.30
A1	0.00	0.03	0.02
b	0.19	0.29	0.24
D	0.595	0.645	0.62
E	0.295	0.345	0.32
e	-	-	0.355
L	0.14	0.24	0.19
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	0.355
G	0.150
X	0.230
X1	0.610
Y	0.300

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